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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/768,904	01/24/2001	Lap-Wai Chow	B-3964 618029-8	4228
75	590 04/19/2004		EXAM	INER
Victor Repkin, Esq.			NGUYEN, JOSEPH H	
c/o LADAS & PARRY Suite 2100			ART UNIT	PAPER NUMBER
5670 Wilshire Boulevard			2815	
Los Angeles, CA 90036-5679			DATE MAILED: 04/19/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)		
	09/768,904	CHOW ET AL.		
Office Action Summary	Examiner	Art Unit		
	Joseph Nguyen	2815		
The MAILING DATE of this communication  Period for Reply	on appears on the cover sheet w	ith the correspondence address		
A SHORTENED STATUTORY PERIOD FOR ITHE MAILING DATE OF THIS COMMUNICAT  - Extensions of time may be available under the provisions of 37 after SIX (6) MONTHS from the mailing date of this communica  - If the period for reply specified above is less than thirty (30) day  - If NO period for reply is specified above, the maximum statutory  - Failure to reply within the set or extended period for reply will, be Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b).	TON.  CFR 1.136(a). In no event, however, may a stion.  It is, a reply within the statutory minimum of third period will apply and will expire SIX (6) MON statute, cause the application to become African and African and African application.	reply be timely filed  ty (30) days will be considered timely.  NTHS from the mailing date of this communication.  BANDONED (35 U.S.C. § 133).		
Status				
1) Responsive to communication(s) filed or	n <u>16 January 2004</u> .			
,				
3) Since this application is in condition for a closed in accordance with the practice u				
Disposition of Claims				
4) ☐ Claim(s) 1-20,23 and 24 is/are pending 4a) Of the above claim(s) is/are w 5) ☐ Claim(s) 1-8,17 and 18 is/are allowed. 6) ☐ Claim(s) 9-16,19 and 20 is/are rejected. 7) ☐ Claim(s) 23 and 24 is/are objected to. 8) ☐ Claim(s) are subject to restriction.	vithdrawn from consideration.			
Application Papers				
9) The specification is objected to by the Example 10) The drawing(s) filed on 05/07/2001 is/arc Applicant may not request that any objection Replacement drawing sheet(s) including the 11) The oath or declaration is objected to by	e: a) accepted or b) object to the drawing(s) be held in abeya correction is required if the drawing	ance. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for a) All b) Some * c) None of:  1. Certified copies of the priority doc 2. Certified copies of the priority doc 3. Copies of the certified copies of the application from the International  * See the attached detailed Office action for	cuments have been received. cuments have been received in he priority documents have bee Bureau (PCT Rule 17.2(a)).	Application No n received in this National Stage		
Attachmant(s)				
Attachment(s)  1) Notice of References Cited (PTO-892)	4) 🔲 Interview	Summary (PTO-413)		
2) Notice of Notice of Notice of Paper No(s)/Mail Date  Notice of	-940)	o(s)/Mail Date  Informal Patent Application (PTO-152)		

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#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 9-16, 19-20 are rejected under 35 U.S.C. 102(e) as being anticipated by Lee et al.

Regarding claim 9, Lee et al discloses on figure 8 a semiconductor device adapted to prevent and/or thwart reverse engineering comprising field oxide layer 33 disposed on a semiconductor substrate 31; a metal plug contact 42 disposed outside a contact region 38b and above said field oxide layer, wherein said metal plug contact is electrically isolated from said contact region; and a metal 43 connected to said metal plug contact 42.

Regarding claim 10, Lee et al discloses on figure 8 said semi-conducting device comprises integrated circuit.

Regarding claim 11, Lee et al discloses on figure 8 said filed oxide layer 33 further comprises silicon oxide.

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Regarding claim 12, Lee et al discloses on figure 8 said integrated circuits further comprise complementary metal oxide semiconductor integrated circuits and bipolar silicon based integrated circuits.

Regarding claim 13, Lee et al discloses on figure 8 a method for preventing and/or thwarting reverse engineering comprising steps of providing a field oxide layer 33 disposed on a semiconductor substrate 31; providing a metal plug contact 42 disposed outside a contact region 38 and above said field oxide layer 33, wherein said metal plug metal is electrically isolated from said contact region; and connecting a metal 43 to said metal plug contact 42.

Regarding claim 14, Lee et al discloses on figure 8 said semi-conducting device comprises integrated circuit.

Regarding claim 15, Lee et al discloses on figure 8 said filed oxide layer 33 further comprises silicon oxide.

Regarding claim 16, Lee et al discloses on figure 8 said integrated circuits further comprise complementary metal oxide semiconductor integrated circuits.

Regarding claim 19, Lee et al discloses on figure 8 said filed oxide layer 33 has an uppermost side, said metal plug contact 42 being deposed on said uppermost side of said field oxide layer.

Regarding claim 20, Lee et al discloses on figure 8 said filed oxide layer 33 has an uppermost side, said metal plug contact 42 being deposed on said uppermost side of said field oxide layer.

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## Allowable Subject Matter

Claims 23-24 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claims 1-8, 17-18 are allowed.

## Response to Arguments

Applicant's arguments with respect to claims 9-16, 19-20 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Joseph Nguyen whose telephone number is (571) 272-1734. The examiner can normally be reached on Monday-Friday, 7:30 am- 4:30 pm

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306 for regular communications. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

JN April 7, 2004

